

PCB Number: SV600821
PCB Rev: A

ZZ1

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2

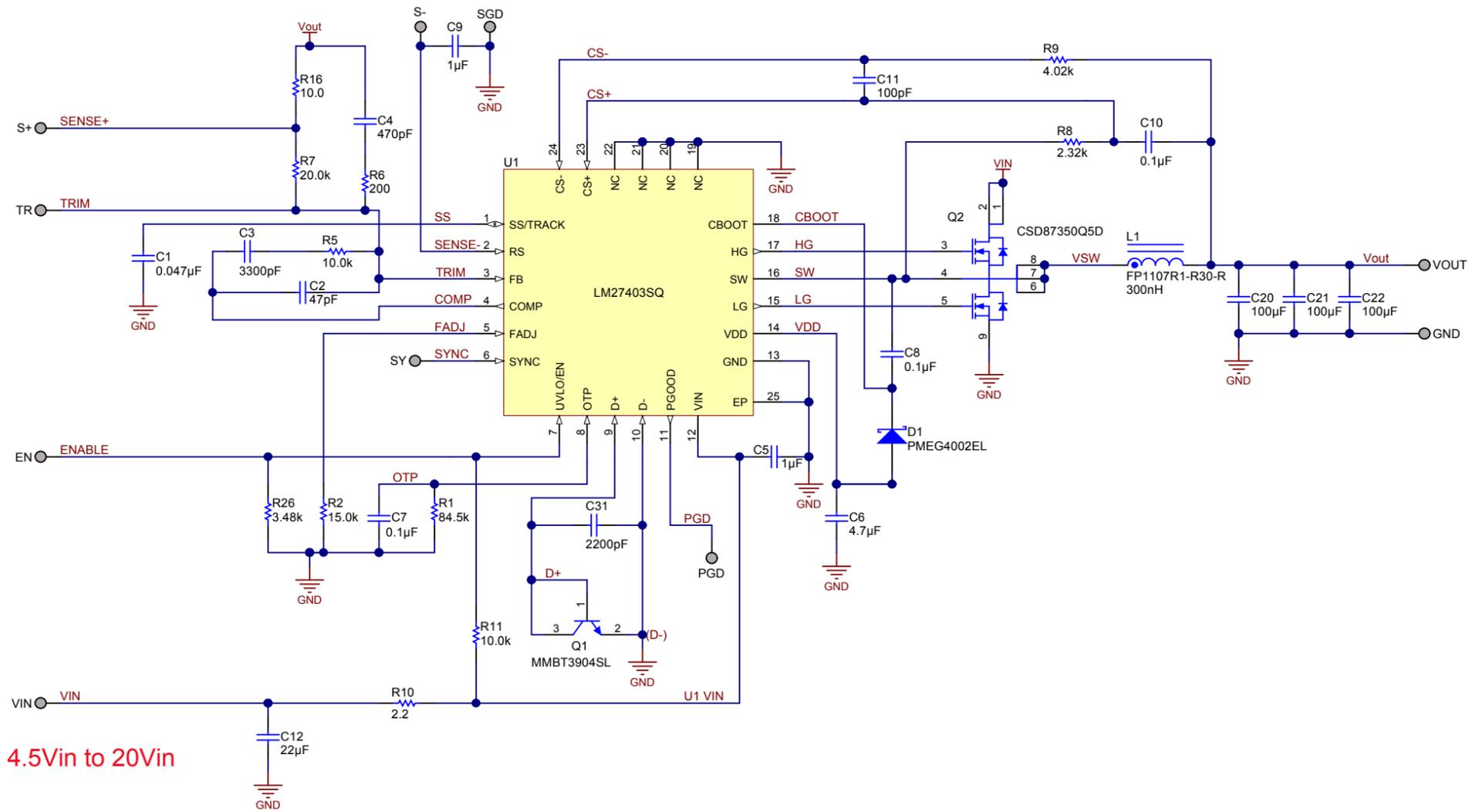
Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.



1.8Vout @ 30A

Input Voltage = 4.5Vin to 20Vin

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SVN Rev: Not in version control	Assembly Variant: 001	Project Title: LM27403MODULEEVM	Sheet Title: ChangeMe
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Engineer: Timothy Hegarty	Contact: http://www.ti.com/support		



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